



# Micro Commercial Components Corp.

Complete Discrete Semiconductor Solutions

Product Catalog > <a href="#">Diodes</a> > <a href="#">Ultra Fast Recovery Rectifiers</a> >	
Part Number	ES1D
product family	ULTRA FAST RECOVERY RECTIFIERS
package type	HSMA
VRM(PRV)	200V
Ifsm	30A
IF(AV)	1.0A
@Vf	0.975V
@If	1.0A
Trr	50nS
IR	5.0μA
@VR	200V
Package Qty	Tape : 3K/Reel, 48K/Ctn;
This product is listed under the following categories where you may find similar products: <a href="#">Diodes</a> <a href="#">Ultra Fast Recovery Rectifiers</a>	



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# ES1A THRU ES1M

## 1 Amp Ultra Fast Recovery Silicon Rectifier 50 to 1000 Volts

### Features

- Lead Free Finish/Rohs Compliant (Note1) ("P" Suffix designates Compliant. See ordering information)
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0 and MSL rating 1
- High Temp Soldering: 260°C for 10 Seconds At Terminals
- Superfast Recovery Times For High Efficiency

### Maximum Ratings

- Operating Temperature: -50°C to +150°C
- Storage Temperature: -50°C to +150°C
- Maximum Thermal Resistance; 15°C/W Junction To Lead

MCC Part Number	Device Marking	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
ES1A	ES1A	50V	35V	50V
ES1B	ES1B	100V	70V	100V
ES1C	ES1C	150V	105V	150V
ES1D	ES1D	200V	140V	200V
ES1G	ES1G	400V	280V	400V
ES1J	ES1J	600V	420V	600V
ES1K	ES1K	800V	560V	800V
ES1M	ES1M	1000V	700V	1000V

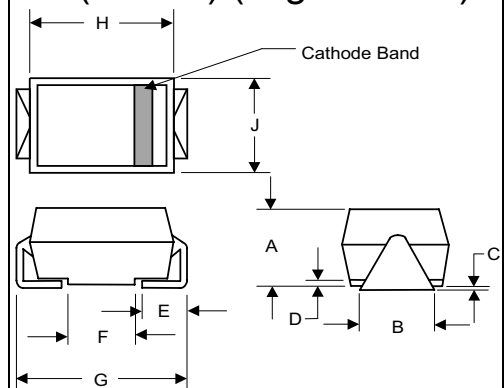
### Electrical Characteristics @ 25°C Unless Otherwise Specified

Average Forward Current	$I_{F(AV)}$	1.0A	$T_a = 75^\circ\text{C}$
Peak Forward Surge Current	$I_{FSM}$	30A	8.3ms, half sine
Maximum Instantaneous Forward Voltage	$V_F$	ES1A-D: .975V ES1G-J: 1.35V ES1K-M: 1.70V	$I_{FM} = 1.0A;$ $T_J = 25^\circ\text{C}^*$
Maximum DC Reverse Current At Rated DC Blocking Voltage	$I_R$	5 $\mu\text{A}$ 100 $\mu\text{A}$	$T_J = 25^\circ\text{C}$ $T_J = 100^\circ\text{C}$
Maximum Reverse Recovery Time	$T_{rr}$	ES1A-D: 50ns ES1G-K: 75ns ES1M: 100ns	$I_F=0.5A, I_R=1.0A,$ $I_{rr}=0.25A$
Typical Junction Capacitance	$C_J$	45pF	Measured at 1.0MHz, $V_R=4.0V$

\*Pulse test: Pulse width 200  $\mu\text{sec}$ , Duty cycle 2%

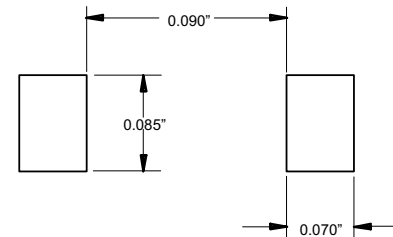
Note: 1. High Temperature Solder Exemptions Applied, see EU Directive Annex 7.

### DO-214AC (HSMA) (High Profile)



DIM	DIMENSIONS				NOTE
	INCHES		MM		
A	.078	.116	1.98	2.95	
B	.067	.089	1.70	2.25	
C	.002	.008	.05	.20	
D	---	.02	---	.51	
E	.035	.055	.89	1.40	
F	.065	.096	1.65	2.45	
G	.205	.224	5.21	5.69	
H	.160	.180	4.06	4.57	
J	.100	.112	2.57	2.84	

### SUGGESTED SOLDER PAD LAYOUT





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## Ordering Information

Device	Packing
(Part Number)-TP	Tape&Reel;3Kpcs/Reel

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